

Customer: Duoke Project: DK086A Structure: Xiao Xiang-13316888409 RF: Long Yaobin 15874137313 Date: June 3, 2024

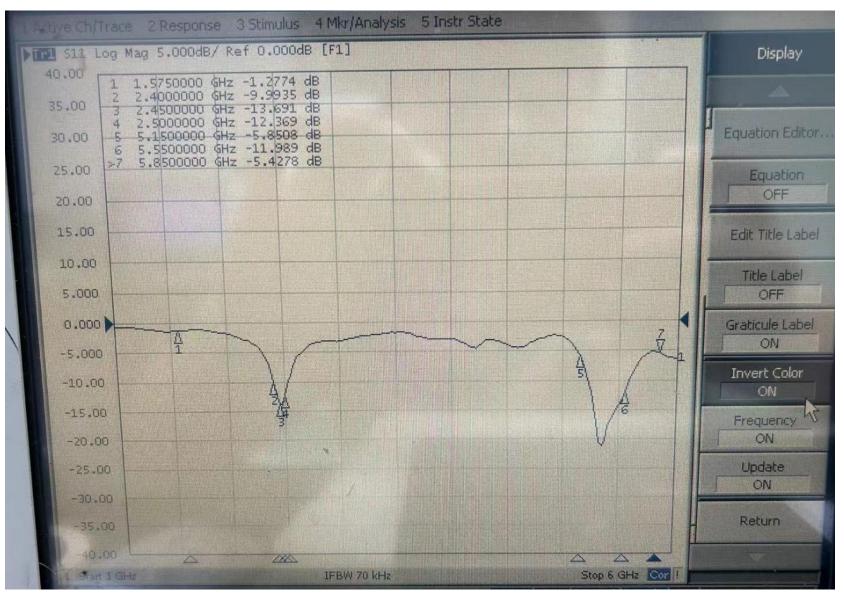


Report type: Version number: V3.0 Machine status: DVT trial production machine **Debugging frequency band:** 802.11a/b/g/n/ac/ax



Antenna debugging data

Antenna LOG MAG:

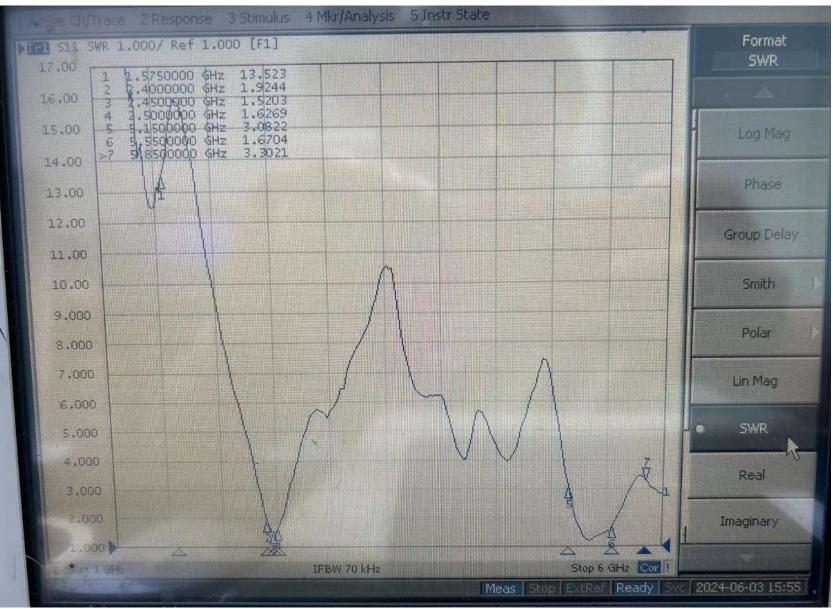


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Antenna debugging data

Antenna SWR:

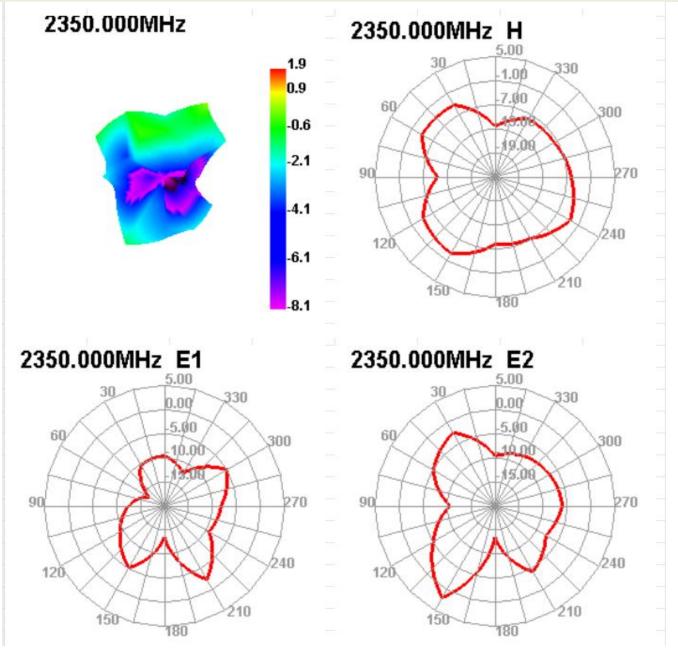


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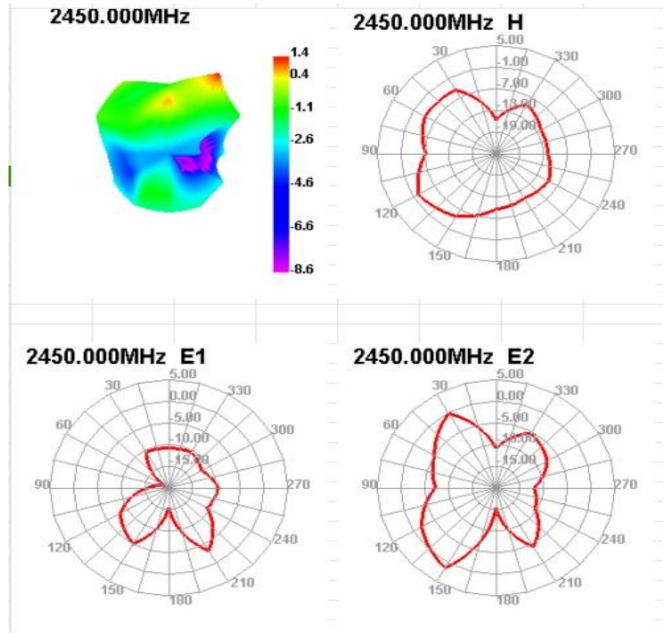
Frequency (MHZ)	Average Gain(dBi)	Peak Gain(dBi)
WIFI 2.4G/BT	-4.8	1.9
WIFI 5.2/5.8G	-5.9	1.3





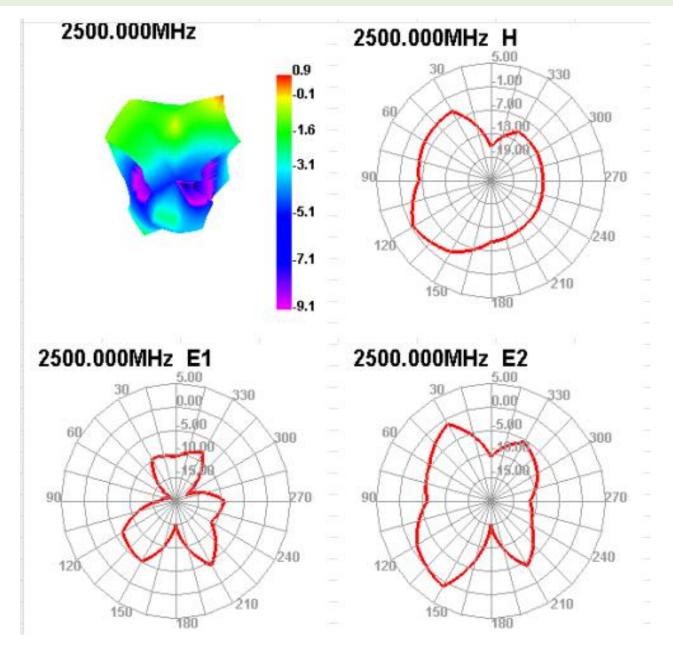
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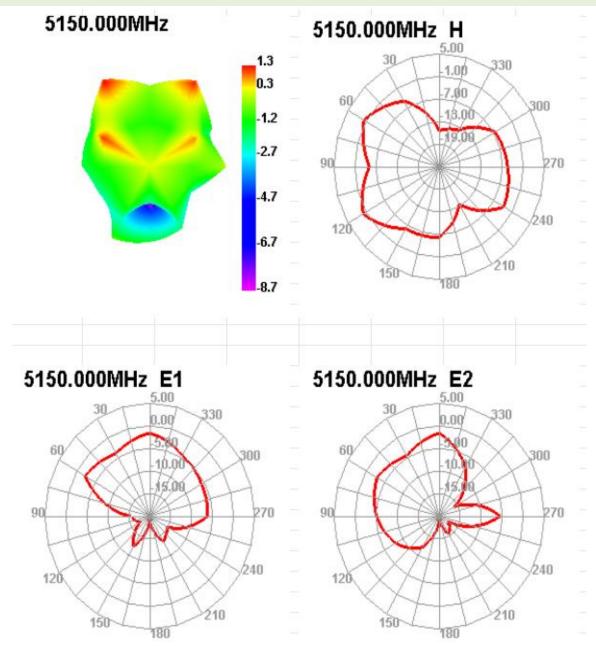
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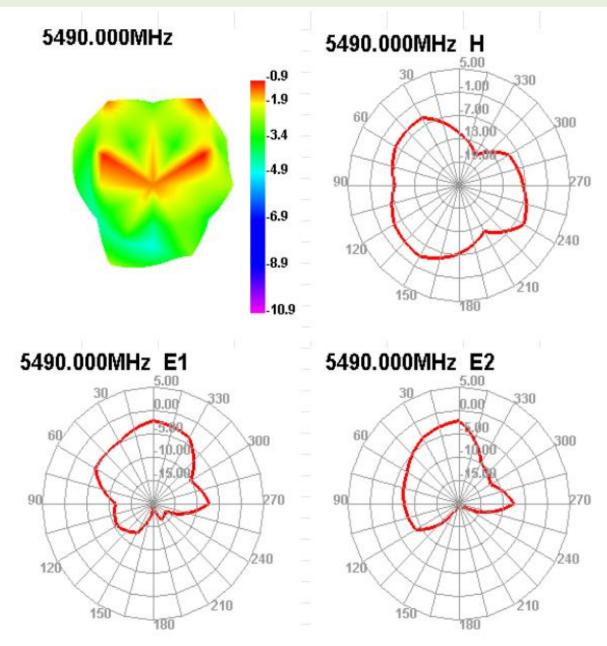
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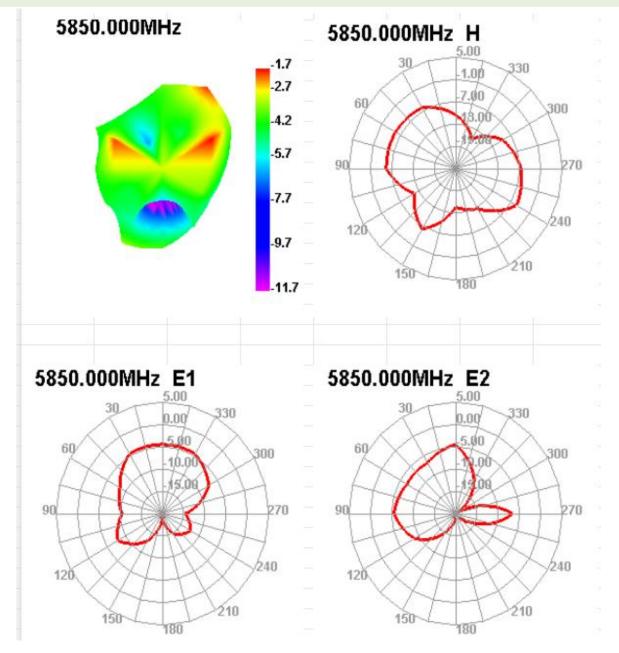
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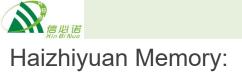




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WIFI OTA						
	Band	Channel	TRP	TIS		
		1	13.6			
	b (11M)	6	12.8			
		13	12.3	-83.6		
2. 4G		1	11.4			
	g (54M)	6	12.1			
		13	11.9	-71.1		
	n (MCS7)	1	12.2			
		6	13. 1			
		13	12.1	-66.3		

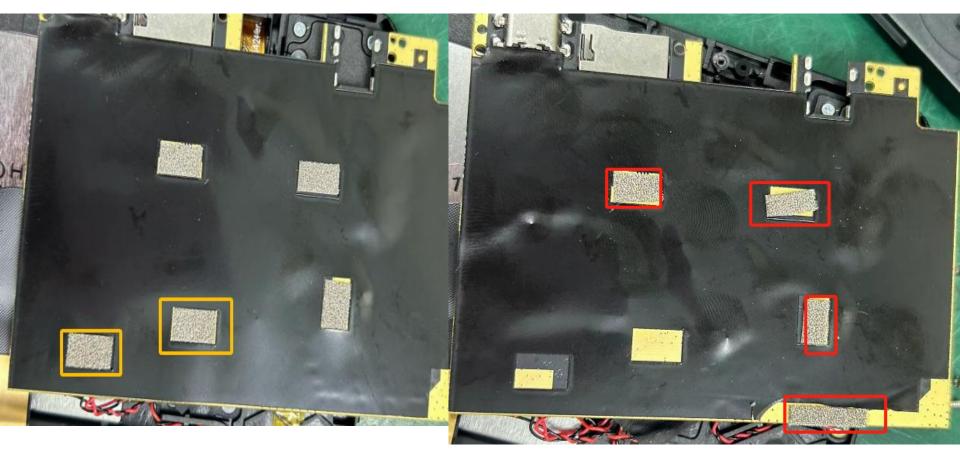


WIFI OTA					
5G	Band	Channel	TRP	TIS	
	a (54M)	36	10.6		
		149	11.3		
		165	11.2	-72.6	
		36	10. 1		
	n (MCS7)	149	11.3		
		165	11.1	-68.2	
	ac(MCS8)	36	10.4		
		149	11.8		
		165	11.5	-67.2	
	ax (MCS8)	36	10.3		
		149	11.5		
		165	11.4	-66.9	



Environmental treatment

As shown in the figure: The original motherboard environment is treated (within the yellow box in the left image below), and the screen ribbon cable is located below the foam, which cannot contact the metal on the back of the screen. Suggest changing the grounding point below the motherboard to the one shown in the red box on the right. Fully ground the motherboard to the metal area of the screen.



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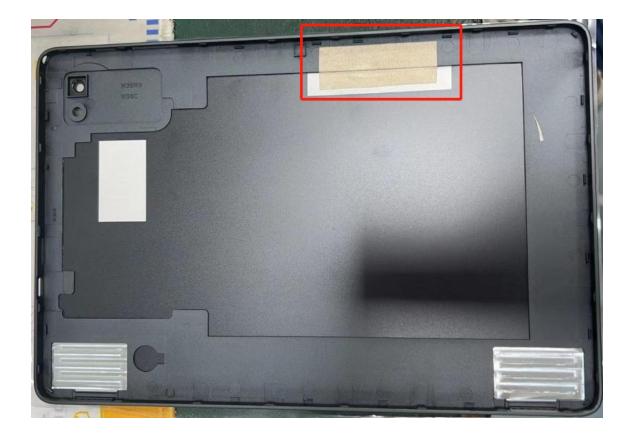
Environmental treatment

As shown in the figure, the back of the motherboard is first covered with insulation glue to shield the components, and the motherboard is pressed down to extend a conductive cloth from the shielding cover to the ground below the battery. Attach a conductive sponge with sufficient height to fully ground the laser engraved area on the back shell of the battery. (Note: The warping of the motherboard has a significant impact on sensitivity. It is necessary to fix the motherboard to prevent warping and fully ground it.)





As shown in the figure: Pull a large conductive cloth from the laser engraved area of the battery back shell to extend onto the plastic bracket. The height of the antenna exposed copper above the plastic bracket is sufficient for conductive foam and the extended conductive cloth to be fully grounded.



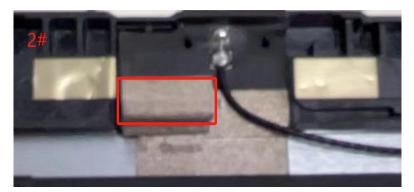


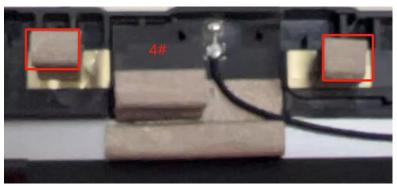
Environmental treatment

The rear shell metal has significant interference with the antenna. The antenna needs to be grounded at multiple points with the metal back shell. As shown in Figure 1-4: After attaching the antenna, first follow the 1 # image to apply a conductive cloth to the exposed copper area of the antenna groove and extend it to the screen metal for grounding. 2. The height of the conductive foam above the antenna groove area is sufficient to ground the metal back shell. 3. The antenna extends above the metal conductive cloth of the screen, and the height of the conductive foam is sufficient to ground the metal back shell. 4. The exposed copper area on both sides of the antenna should have a sufficient height for conductive foam to be grounded with the metal back shell.











Antenna diagram

